

# RBA30N04DANS-4UB10

# N-Channel Power MOSFET

 $40V - 30A - 10m\Omega$ 

### **Description**

Renesas SO8-FL technology in 5x6mm2 flat-lead package designed for supporting high current with copper clip-applied, compact & efficient designs and including optimal thermal performance. AEC-Q101 qualified MOSFET and PPAP capable suitable for automotive applications.

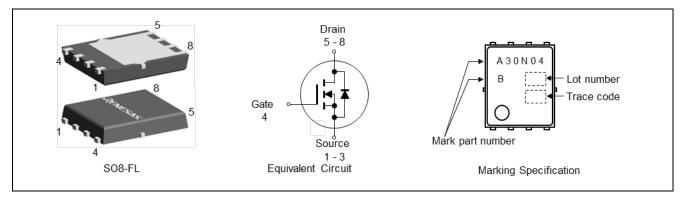
#### **Features**

- Standard level gate drive voltage: V<sub>GS(th)</sub> = 2.0~4.0V
- Low on-state resistance to minimize conduction losses:  $R_{DS(on)} = 10 m\Omega$  Max.
- Low input capacitance to minimize driver losses
- Small footprint (5x6mm²) with compact design
- AEC-Q101 qualified
- PPAP capable
- Pb-free lead plating: RoHS compliant
- MSL1 classified according to IPC/JEDEC J-STD-020

#### **Application**

- Automotive: 12V/24V load EPS, ABS, PSM, BMS, e-fuse, etc.
- Industrial: Micro inverter, DC-DC converter, Power-tool, battery powered application, etc.

#### **Outline**



### **Absolute Maximum Ratings**

(T<sub>j</sub>=25°C unless otherwise notice.)

Item	Symbol	Ratings	Unit
Drain to Source Voltage	V <sub>DSS</sub>	40	V
Gate to Source Voltage	V <sub>GSS</sub>	±20	V
Drain Current (DC)	I <sub>D(DC)</sub> Notes1,2,5	±30	Α
Drain Current (pulse)	I <sub>D(pulse)</sub> Notes1,3,5	±90	Α
Power Dissipation	P <sub>D</sub> Notes1,5	26	W
Junction Temperature	Tj	175	°C
Storage Temperature	T <sub>stg</sub>	-55 to 175	°C
Single Avalanche Current	I <sub>AS</sub> Notes4	13	Α
Single Avalanche Energy	E <sub>AS</sub> Notes4	17	mJ

### **Thermal Resistance**

Item	Symbol	Max.	Unit
Junction to Case Thermal Resistance	R <sub>th(j-c)</sub> Notes5	5.8	°C/W

### **Electrical Characteristics**

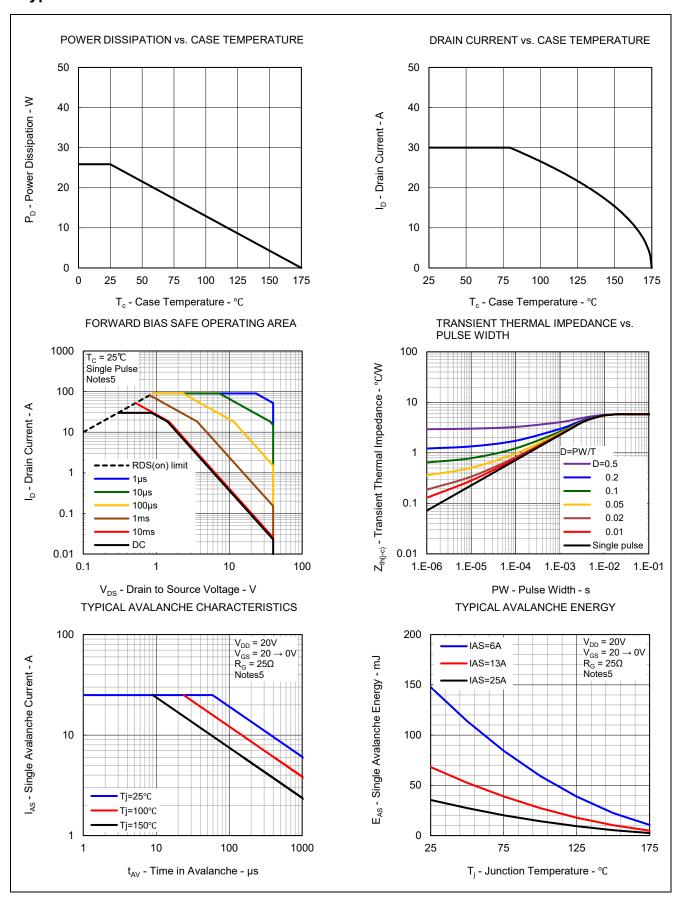
(T<sub>j</sub>=25°C unless otherwise notice.)

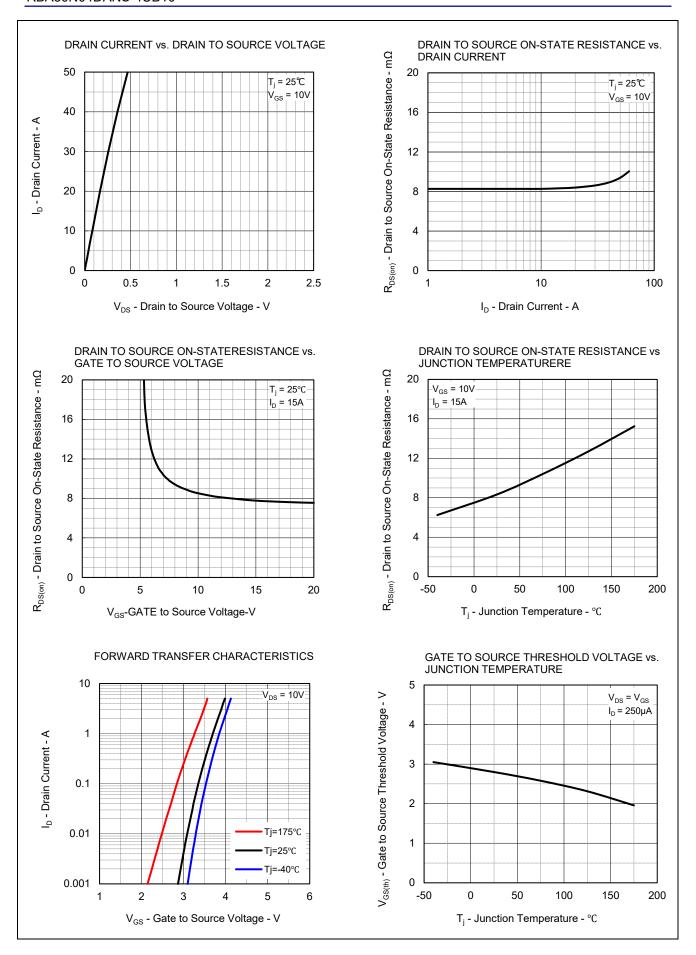
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V
Gate Leakage Current	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS}$ = $\pm$ 20 V, $V_{DS}$ = 0 V
Gate to Source Threshold Voltage	$V_{GS(th)}$	2.0	_	4.0	<b>V</b>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$
Drain to Source On-state Resistance	R <sub>DS(on)</sub>	_	8.33	10	mΩ	$V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$
Input Capacitance	C <sub>iss</sub>	_	770	_	pF	V <sub>DS</sub> = 25 V
Output Capacitance	Coss	_	92	_	pF	V <sub>GS</sub> = 0 V
Reverse Transfer Capacitance	C <sub>rss</sub>	_	69	_	pF	f = 1 MHz
Gate resistance	R <sub>g</sub>	_	2.1	_	Ω	
Turn-on Delay Time	t <sub>d(on)</sub>	_	10	_	ns	V <sub>DD</sub> = 20 V, I <sub>D</sub> = 15 A
Rise Time	t <sub>r</sub>	_	4	_	ns	V <sub>GS</sub> = 10 V
Turn-off Delay Time	$t_{d(off)}$	_	25	_	ns	$R_G = 5 \Omega$
Fall Time	t <sub>f</sub>	_	7.3	_	ns	
Total Gate Charge	Qg	_	19	_	nC	V <sub>DD</sub> = 20 V
Gate to Source Charge	$Q_{gs}$	_	5.7	_	nC	V <sub>GS</sub> = 10 V
Gate to Drain Charge	$Q_{gd}$	_	5	_	nC	I <sub>D</sub> = 15 A
Body Diode Forward Voltage	$V_{F(S-D)}$	_	0.83	1.5	V	I <sub>F</sub> = 15 A, V <sub>GS</sub> = 0 V
Reverse Recovery Time	t <sub>rr</sub>	_	25	_	ns	I <sub>F</sub> = 15 A, V <sub>GS</sub> = 0 V
Reverse Recovery Charge	Q <sub>rr</sub>	_	17	_	nC	di/dt = 100 A/μs

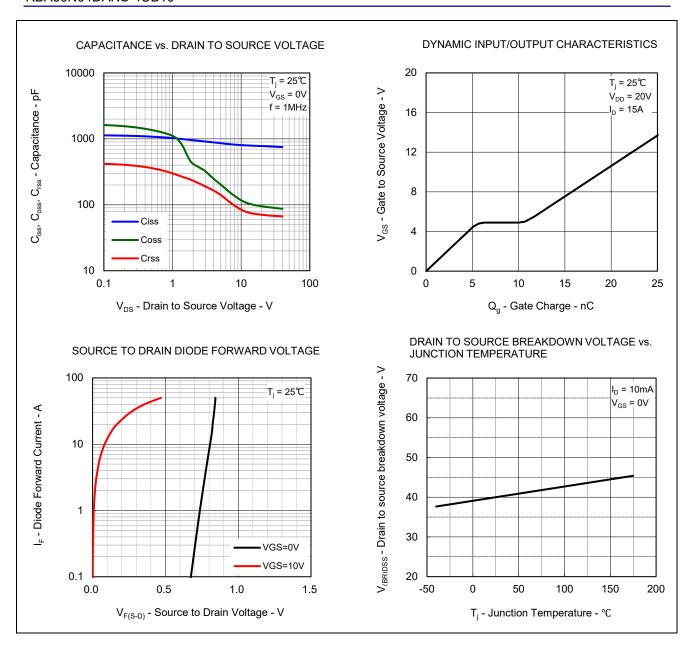
Notes 1.  $T_c = 25$ °C

- 2. Value is limited by overall system design including PCB.
- 3. PW  $\leq$  10  $\mu s$  , Duty Cycle  $\leq$  1%
- 4. L = 100 $\mu H$  ,  $V_{DD}$  = 20V ,  $V_{GS}$  = 20  $\rightarrow$  0V ,  $R_{G}$  = 25  $\Omega$
- 5. Defined by design. Not subject to production test.

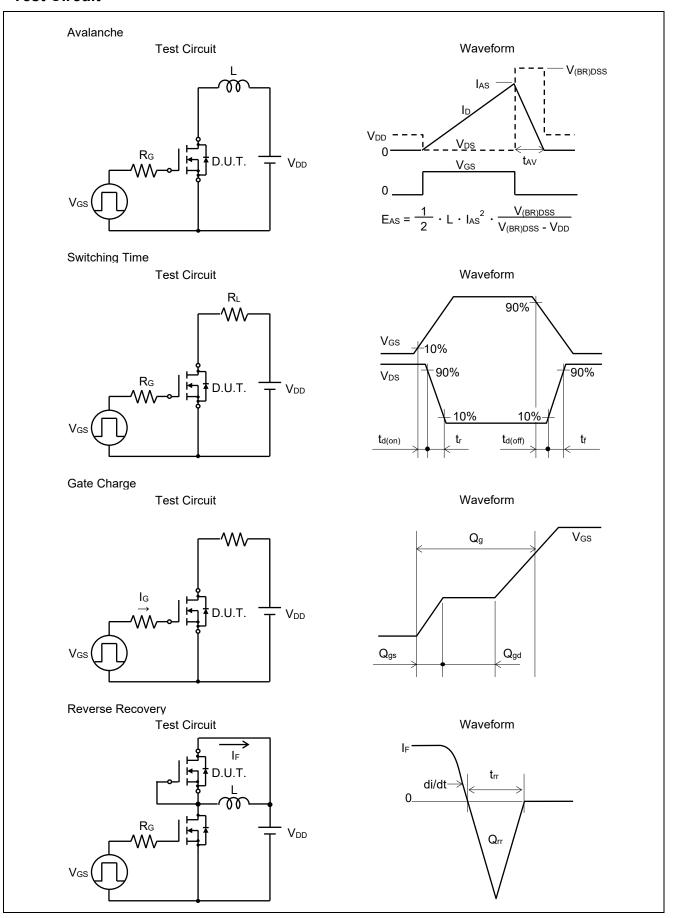
### **Typical Characteristics**



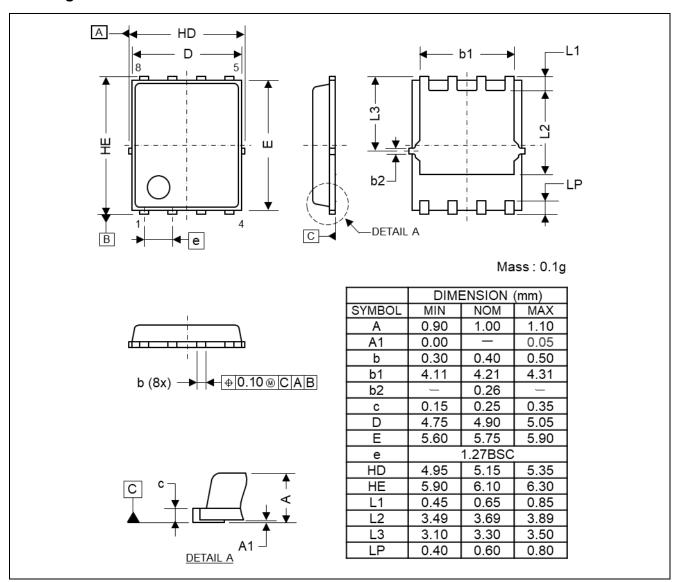




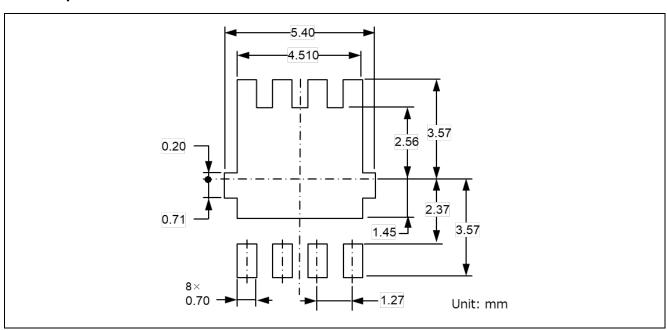
### **Test Circuit**



### **Package Dimensions**



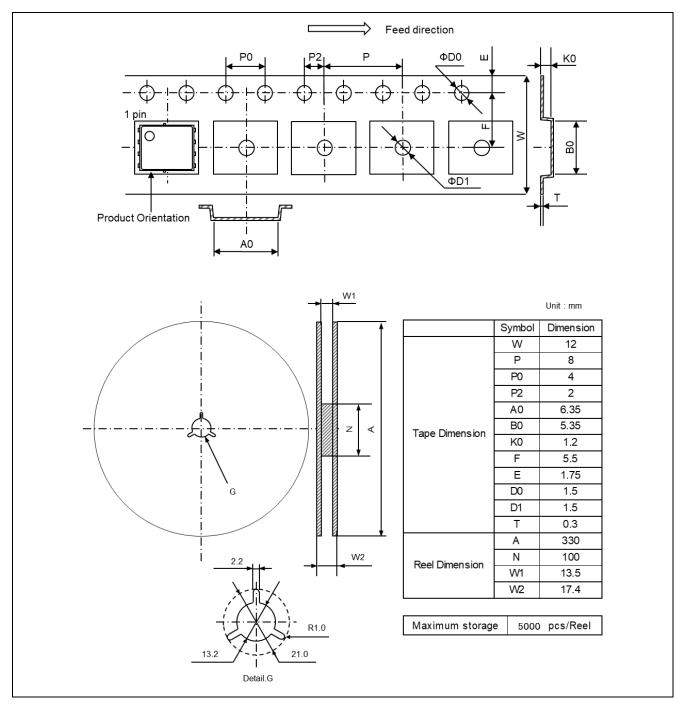
### **Mount pad**



### **Ordering Information**

Part No.	Packing	Quantity
RBA30N04DANS-4UB10#HB0	Taping	5000pcs/reel

## **Packing Specification**



Remark: Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

Continuous heavy condition (e.g. high temperature/voltage/current or high variation of temperature) may affect reliability even if it is within the absolute maximum ratings. Please consider derating condition for appropriate reliability in reference Renesas Semiconductor Reliability Handbook.

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